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Applicant: Kahn et al. Docket No.: TI-24186.2
Serial No: 10/727,740 Examiner: Tran, K.
Filed: 12/04/2003 Art Unit: 3651
Customer No.: 23494 Conf. No.: 7173

For: IN-SITU RANDOMIZATION AND RECORDING OF WAFER
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NAME OF INVENTOR(S): Kahn et al	
TITLE OF INVENTION: In-situ Randomization . . .	
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FAXED: 6/1/2005 DUE: 4/5/2005 ATTY/SECY: JJG	
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